

FGW35N60HC

Discrete IGBT

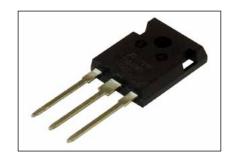
Discrete IGBT (High-Speed V series) 600V / 35A

■ Features

Low power loss Low switching surge and noise High reliability, high ruggedness (RBSOA, SCSOA etc.)

Applications

Uninterruptible power supply Power coditionner Power factor correction circuit

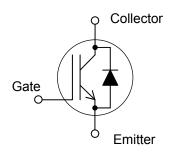


■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings (at T_j=25°C unless otherwise specified)

Items	Symbols	Characteristics	Units	Remarks
Collector-Emitter Voltage	Vces	600	V	
Gate-Emitter Voltage	V _{GES}	±20	V	
DC Collector Current	Ic@25	64	Α	Tc=25°C,Tj=150°C
DC Collector Current	Ic@100	35	Α	Tc=100°C,Tj=150°C
Pulsed Collector Current	Icp	105	Α	Note *1
Turn-Off Safe Operating Area	-	105	Α	Vce≤600V,Tj≤175°C
Diode Forward Current	IF@25	55	Α	
	F@100	35	Α	
Diode Pulsed Current	IFP	105	Α	Note *1
Short Circuit Withstand Time	tsc	5	μs	Vcc≤300V,VgE=12V Tj≤150°C
IGBT Max. Power Dissipation	P _{D_IGBT}	230	W	Tc=25°C
FWD Max. Power Dissipation	P _{D_FWD}	125	VV	Tc=25°C
Operating Junction Temperature	T _i	-40 ~ +175	°C	
Storage Temperature	T _{stg}	-55 ~ +175	°C	

■ Equivalent circuit



Note *1 : Pulse width limited by Tjmax.

● Electrical characteristics (at T_i= 25°C unless otherwise specified)

Description	Cumbala	ls Conditions		Characteristics		
Description	Symbols	Conditions	min.	typ.	max.	Units
Collector-Emitter Breakdown Voltage	V _{(BR)CES}	$I_{C} = 250 \mu A$, $V_{GE} = 0 V$	600	-	-	V
Zero Gate Voltage Collector Current	Ices	V _{CE} = 600V, V _{CE} = 0V	-	-	250	μA
Zero Gate Voltage Goliector Gurrent	ICES	I _j =1/5°C	-	-	10	mA
Gate-Emitter Leakage Current	Iges	$V_{CE} = 0V$, $V_{GE} = \pm 20V$	-	-	200	nA
Gate-Emitter Threshold Voltage	VGE (th)	V _{CE} = +20V, I _C = 35mA	4.0	5.0	6.0	V
Collector-Emitter Saturation Voltage	VCE (sat)	V _{GE} = +15V, I _C = 35A	-	1.50 1.80	1.95	V
Input Capacitance	Cies	V _{CE} =25V	-	2800	-	pF
Output Capacitance	Coes	V _{GE} =0V	-	140	-	
Reverse Transfer Capacitance	Cres	f=1MHz	-	100	-	
Gate Charge	Q _G	V _{CC} = 400V I _C = 35A V _{GE} = 15V	-	210	-	nC
Turn-On Delay Time	t _{d(on)}	$T_i = 25^{\circ}C$	-	32	-	
Rise Time	t	Vcc = 400V	-	52	-	ns
Turn-Off Delay Time	t _{d(off)}	Ic = 35A	-	200	-	
Fall Time	t _f	V _{GE} = 15V	-	40	-	
Turn-On Energy	Eon	$R_G = 10\Omega$	-	0.95	-	
Turn-Off Energy	E _{off}	L = 500µH Energy loss include "tail" and FWD reverse recovery.	-	0.85	-	mJ
Turn-On Delay Time	t _{d(on)}			32	-	
Rise Time	t	Vcc = 400V	-	52	-	ns
Turn-Off Delay Time	t _{d(off)}	Ic = 35A V _{GE} = 15V		225	-	lis
Fall Time	tr			50	-	
Turn-On Energy	Eon	$R_G = 10\Omega$	-	1.55	-	
Turn-Off Energy	Eoff	L = 500µH Energy loss include "tail" and FWD reverse recovery.	-	1.25	-	mJ

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● FWD Characteristics

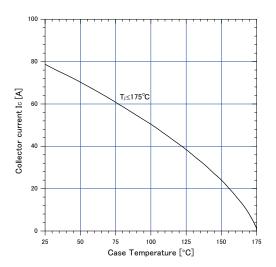
Description	Symbol	Conditions	anditions		Characteristics			
Description	Зушьог	Symbol		min.	typ.	max.	Unit	
Forward Voltage Drop	VF	I=35A	T _j =25°C	-	2.35	3.00	V	
Forward voitage brop	VF	IF-33A	T _j =175°C	-	1.75	-	V	
Diode Reverse Recovery Time	+ .	Vcc=30V,I _F = 3.5A		_	30	41	ns	
Diode Reverse Recovery Time	Lrr1	-di/dt=200A/µs						
Diode Reverse Recovery Time	t _{rr2}	Vcc=400V			0.05	_	μs	
Blode Reverse Recovery Time		I⊧=35A		0.00		μσ		
Diode Reverse Recovery Charge	Qrr	-di⊧/dt=200A/μs		_	0.13	_	μC	
Production of the service of the ser		T _j =25°C			00			
Diode Reverse Recovery Time	t _{rr2}	Vcc=400V		_	0.16	_	μs	
	1	I⊧=35A		2				
Diode Reverse Recovery Charge	Qrr	-di⊧/dt=200A/µs		_	1.00	_	μC	
	~	T _i =175°C					ا ۳۰	

● Thermal Resistance

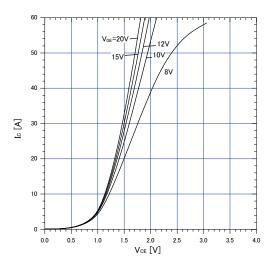
Description	Symbols Conditions	Conditions	Characteristics			Units
		Conditions	min.	typ.	max.	Units
Thermal Resistance, Junction-Ambient	R _{th(j-a)}	-	-	-	50	
Thermal Resistance, IGBT Junction to Case	R _{th(j-c)_IGBT}	-	-	-	0.641	°C/W
Thermal Resistance, FWD Junction to Case	R _{th(j-c)_FWD}	-	-	-	1.191	

■ Characteristics (Representative)

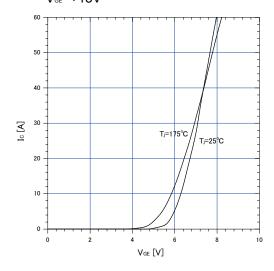
Graph.1 DC Collector Current vs T_c $V_{ce} \ge +15V$, $T_i \le 175$ °C



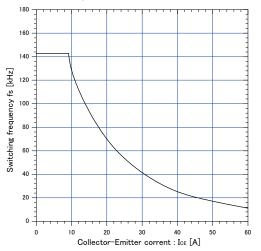
Graph.3
Typical Output Characteristics (VcE-lc)
T,=25°C



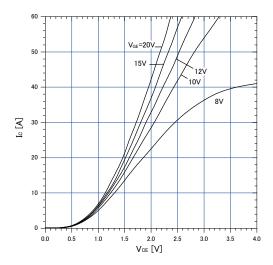
Graph.5 Typical Transfer Characteristics V_{GE} =+15V



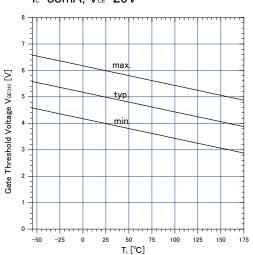
Graph.2 Collector Current vs. switching frequency V_{ce} =+15V, T_{c} ≤175°C, V_{cc} =400V, D=0.5, R_{e} =10 Ω , T_{c} =100°C



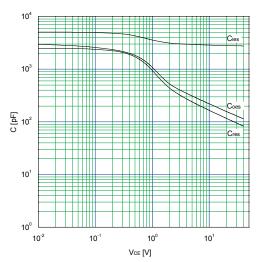
Graph.4
Typical Output Characteristics (V_{c∈}-I_c)
T_i=175°C



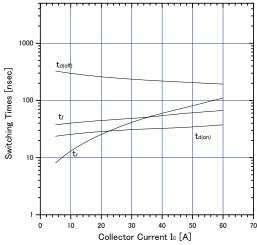
Graph.6
Gate Threshold Voltage vs. T_i
I_c=35mA, V_{cε}=20V



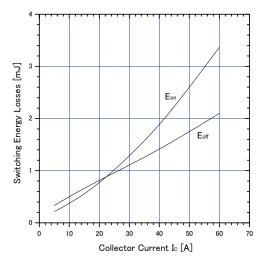
Graph.7 Typical Capacitance V₀=0V,f=1MHz,T,=25°C



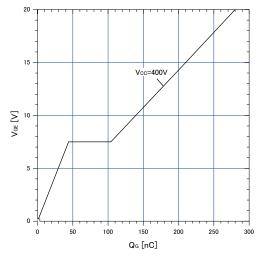
Graph.9 Typical switching time vs. I_c T_J=175°C,V_{cc}=400V,L=500 μ H V_{GE}=15V,R_G=10 Ω



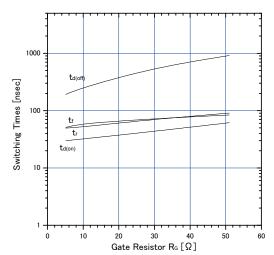
Graph.11 Typical switching losses vs. Io $T_{\rm J}$ =175°C, $V_{\rm cc}$ =400V,L=500 μ H $V_{\rm ce}$ =15V, $R_{\rm c}$ =10 Ω



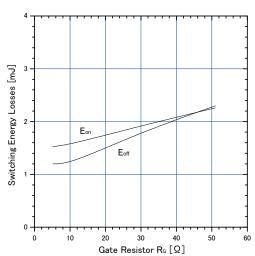
Graph.8 Typical Gate Charge V∞=400V,I₀=35A,T₀=25°C



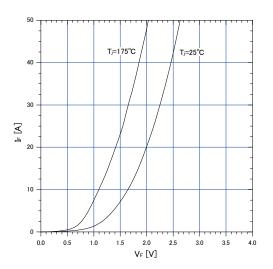
Graph.10
Typical switching time vs. R_s
T_i=175°C,V_{cc}=400V,I_c=35A,L=500μH
V_{sε}=15V



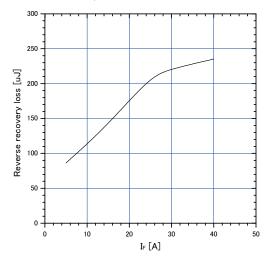
Graph.12 Typical switching losses vs. $R_{\rm s}$ $T_{\rm j}$ =175°C, $V_{\rm cc}$ =400V, $I_{\rm c}$ =35A,L=500 μ H $V_{\rm ce}$ =15V



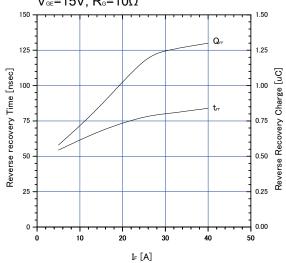
Graph.13 FWD Forward voltage drop (V_F-I_F)



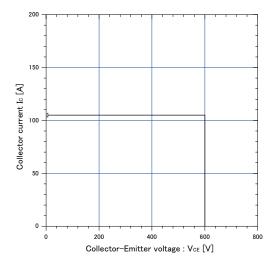
Graph.15 Typical reverse recovery loss vs. I_F T_J =175°C, V_{cc} =400V, L=500 μ H V_{ce} =15V, R_c =10 Ω



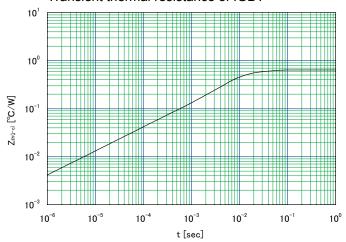
Graph.14 Typical reverse recovery characteristics vs. I_{F} T_{J} =175°C, V_{cc} =400V, L=500 μH V_{ce} =15V, R_{c} =10 Ω



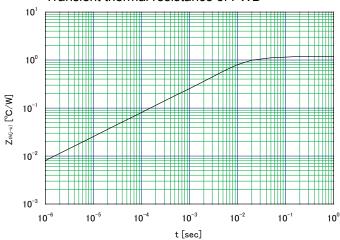
Graph.16
Reverse biased Safe Operating Area $T_i \le 175^{\circ}C$, $V_{\text{GE}} = +15V/0V$, $R_{\text{G}} = 10\Omega$



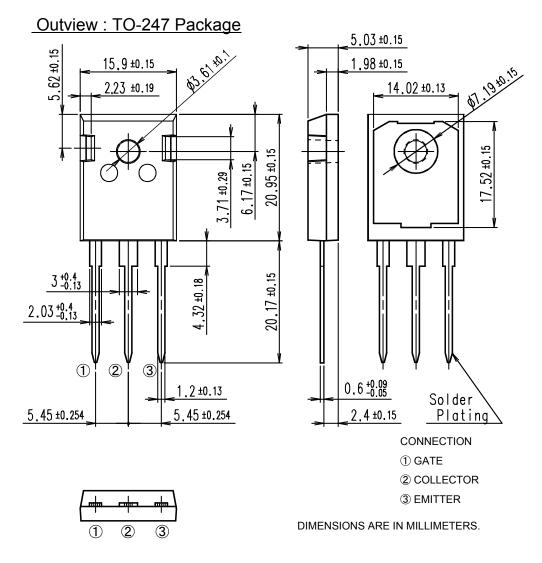
Graph.17 Transient thermal resistance of IGBT



Graph.18
Transient thermal resistance of FWD



■ Outline Drawings, mm



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